

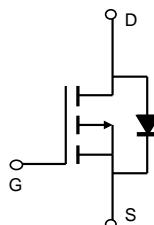
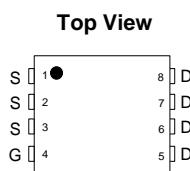
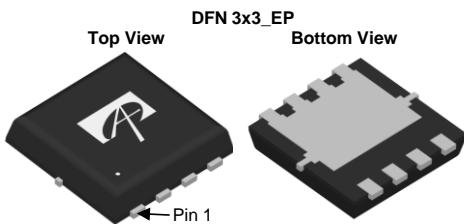
### General Description

The AON7401 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , and ultra-low low gate charge with a 25V gate rating. This device is suitable for use as a load switch or in PWM applications.

### Product Summary

|                                  |        |
|----------------------------------|--------|
| $V_{DS}$                         | -30V   |
| $I_D$ (at $V_{GS}=-10V$ )        | -35A   |
| $R_{DS(ON)}$ (at $V_{GS}=-10V$ ) | < 14mΩ |
| $R_{DS(ON)}$ (at $V_{GS}=-6V$ )  | < 17mΩ |

100% UIS Tested  
100%  $R_g$  Tested



### Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

| Parameter                              | Symbol         | Maximum    | Units |
|--|----------------|------------|-------|
| Drain-Source Voltage                   | $V_{DS}$       | -30        | V     |
| Gate-Source Voltage                    | $V_{GS}$       | $\pm 25$   | V     |
| Continuous Drain Current               | $I_D$          | -35        | A     |
| $T_C=100^\circ\text{C}$                |                | -23        |       |
| Pulsed Drain Current <sup>c</sup>      | $I_{DM}$       | -80        |       |
| Continuous Drain Current               | $I_{DSM}$      | -12        | A     |
| $T_A=70^\circ\text{C}$                 |                | -9.7       |       |
| Power Dissipation <sup>b</sup>         | $P_D$          | 29         | W     |
| $T_C=100^\circ\text{C}$                |                | 12         |       |
| Power Dissipation <sup>a</sup>         | $P_{DSM}$      | 3.1        | W     |
| $T_A=70^\circ\text{C}$                 |                | 2          |       |
| Junction and Storage Temperature Range | $T_J, T_{STG}$ | -55 to 150 | °C    |

### Thermal Characteristics

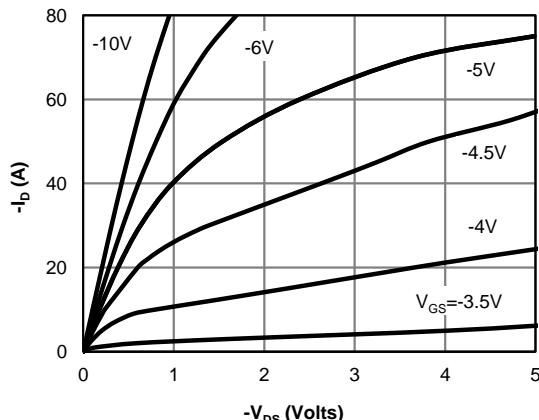
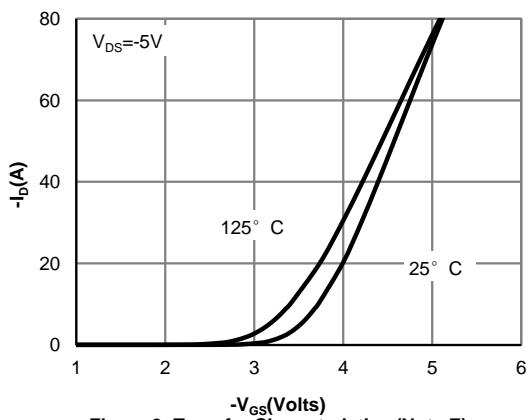
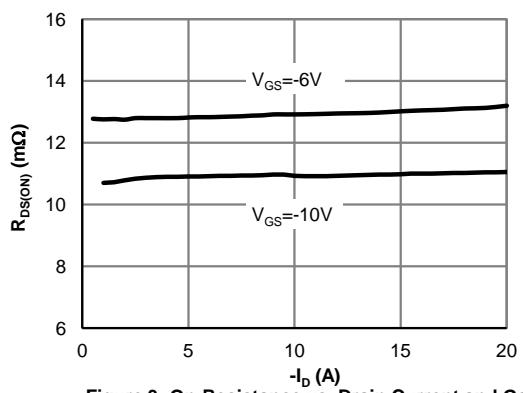
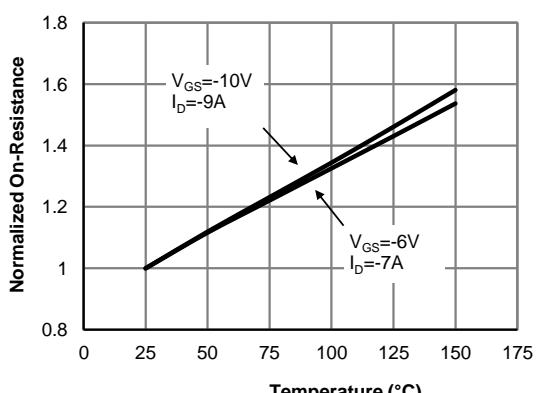
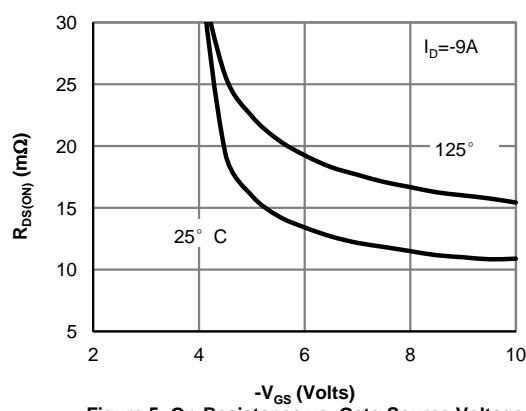
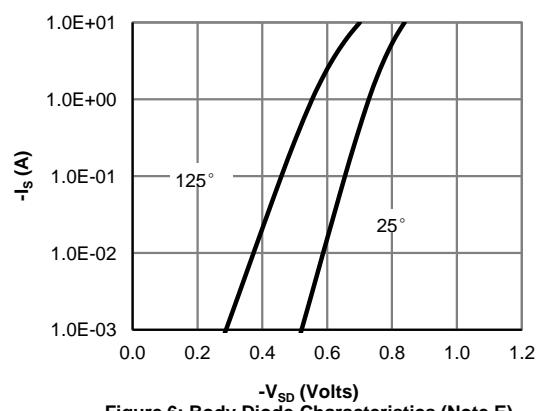
| Parameter                                  | Symbol          | Typ | Max | Units |
|--|-----------------|-----|-----|-------|
| Maximum Junction-to-Ambient <sup>a</sup>   | $R_{\theta JA}$ | 30  | 40  | °C/W  |
| Maximum Junction-to-Ambient <sup>a,d</sup> |                 | 60  | 75  | °C/W  |
| Maximum Junction-to-Lead                   | $R_{\theta JL}$ | 3.5 | 4.2 | °C/W  |

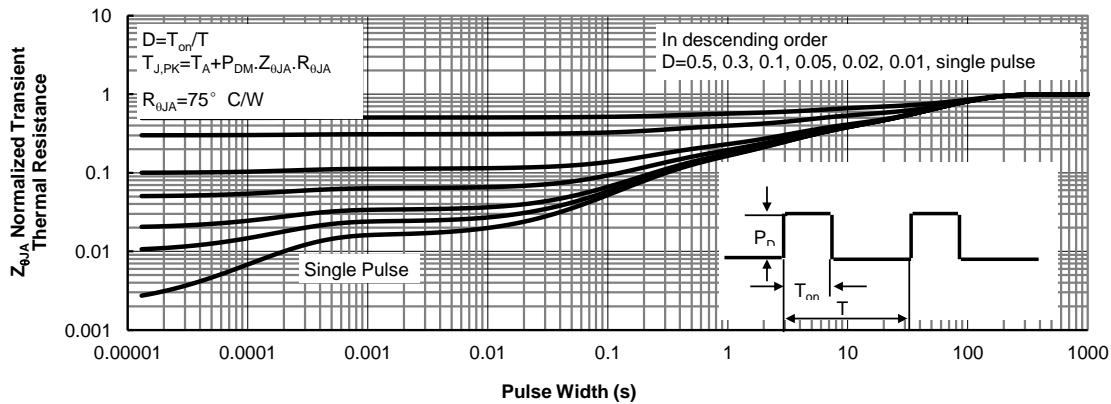
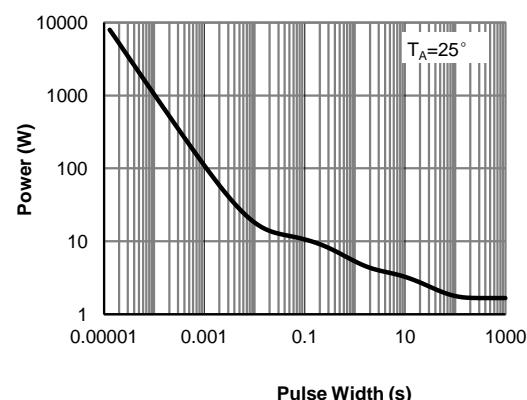
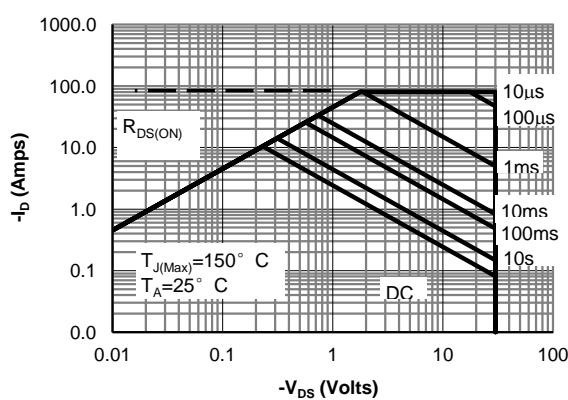
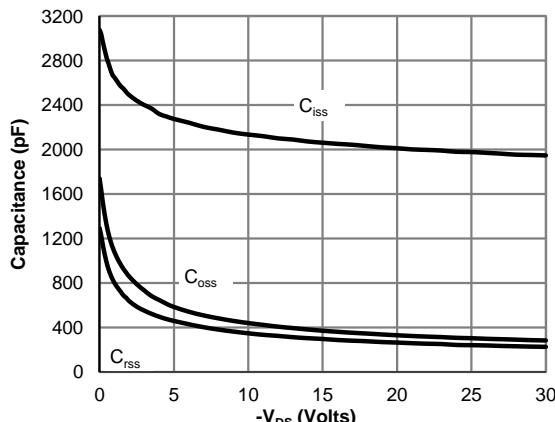
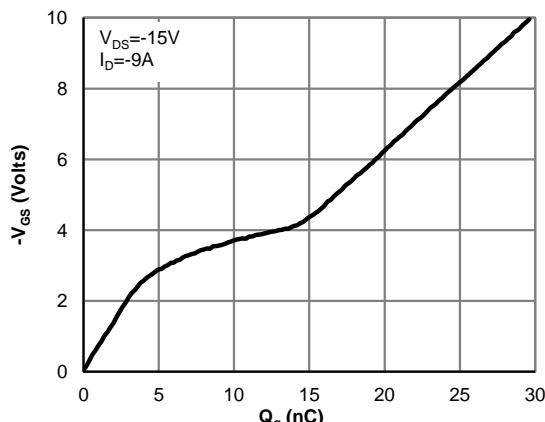
**Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

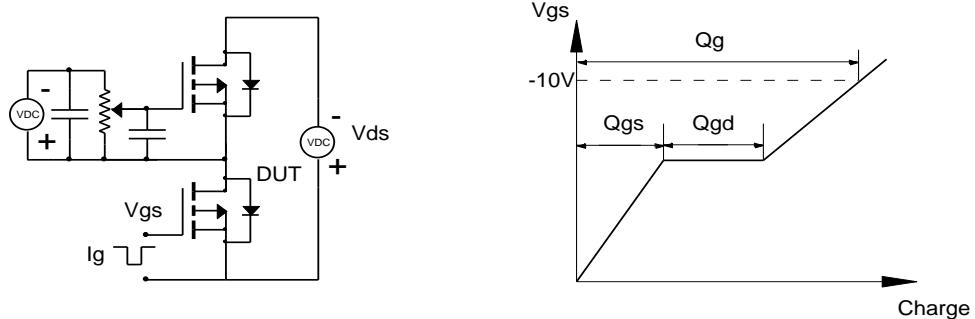
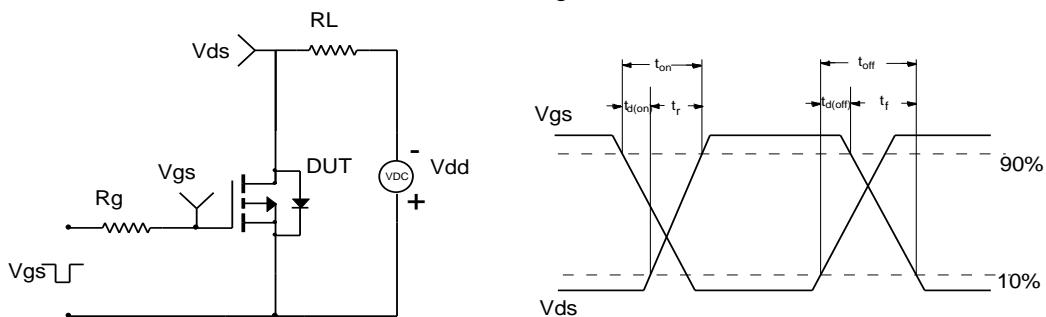
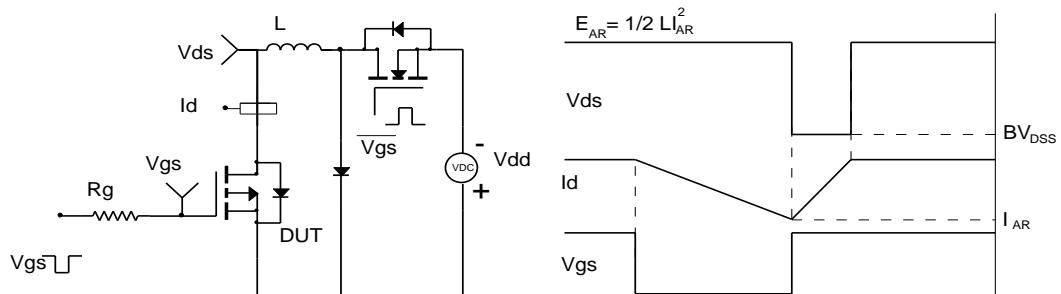
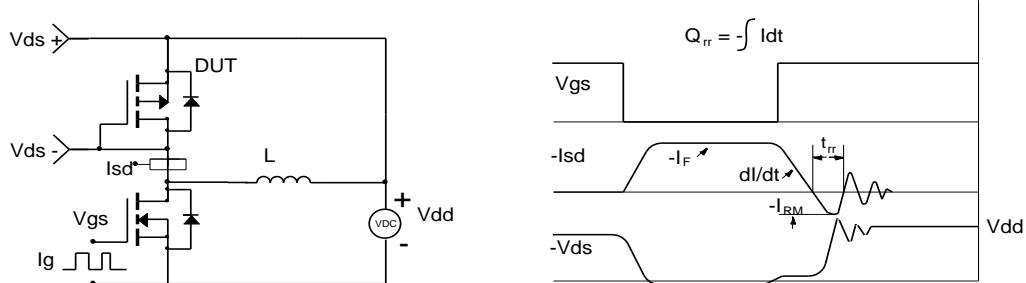
| Symbol                      | Parameter                             | Conditions  | Min  | Typ      | Max       | Units            |
|-----------------------------|---------------------------------------|---|------|----------|-----------|------------------|
| <b>STATIC PARAMETERS</b>    |                                       |   |      |          |           |                  |
| $\text{BV}_{\text{DSS}}$    | Drain-Source Breakdown Voltage        | $I_D=-250\mu\text{A}, V_{GS}=0\text{V}$   | -30  |          |           | V                |
| $I_{\text{DSS}}$            | Zero Gate Voltage Drain Current       | $V_{DS}=-30\text{V}, V_{GS}=0\text{V}$<br>$T_J=55^\circ\text{C}$                |      |          | -1<br>-5  | $\mu\text{A}$    |
| $I_{\text{GSS}}$            | Gate-Body leakage current             | $V_{DS}=0\text{V}, V_{GS}= \pm 25\text{V}$                                      |      |          | $\pm 100$ | nA               |
| $V_{\text{GS(th)}}$         | Gate Threshold Voltage                | $V_{DS}=V_{GS}, I_D=-250\mu\text{A}$  | -1.7 | -2.2     | -3        | V                |
| $I_{\text{D(ON)}}$          | On state drain current                | $V_{GS}=-10\text{V}, V_{DS}=-5\text{V}$   | -80  |          |           | A                |
| $R_{\text{DS(ON)}}$         | Static Drain-Source On-Resistance     | $V_{GS}=-10\text{V}, I_D=-9\text{A}$<br>$T_J=125^\circ\text{C}$                 |      | 11<br>16 | 14<br>19  | $\text{m}\Omega$ |
|                             |                                       | $V_{GS}=-6\text{V}, I_D=-7\text{A}$   |      | 12.9     | 17        | $\text{m}\Omega$ |
| $g_{\text{FS}}$             | Forward Transconductance              | $V_{DS}=-5\text{V}, I_D=-9\text{A}$   |      | 27       |           | S                |
| $V_{\text{SD}}$             | Diode Forward Voltage                 | $I_S=-1\text{A}, V_{GS}=0\text{V}$  |      | -0.7     | -1        | V                |
| $I_S$                       | Maximum Body-Diode Continuous Current |   |      |          | -25       | A                |
| <b>DYNAMIC PARAMETERS</b>   |                                       |   |      |          |           |                  |
| $C_{\text{iss}}$            | Input Capacitance                     | $V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1\text{MHz}$                           |      | 2060     | 2600      | pF               |
| $C_{\text{oss}}$            | Output Capacitance                    |   |      | 370      |           | pF               |
| $C_{\text{rss}}$            | Reverse Transfer Capacitance          |   |      | 295      |           | pF               |
| $R_g$                       | Gate resistance                       | $V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$                             |      | 2.4      | 3.6       | $\Omega$         |
| <b>SWITCHING PARAMETERS</b> |                                       |   |      |          |           |                  |
| $Q_g(10\text{V})$           | Total Gate Charge                     | $V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, I_D=-9\text{A}$                        |      | 30       | 39        | nC               |
| $Q_{\text{gs}}$             | Gate Source Charge                    |   |      | 4.6      |           | nC               |
| $Q_{\text{gd}}$             | Gate Drain Charge                     |   |      | 10       |           | nC               |
| $t_{\text{D(on)}}$          | Turn-On DelayTime                     | $V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, R_L=1.6\Omega, R_{\text{GEN}}=3\Omega$ |      | 11       |           | ns               |
| $t_r$                       | Turn-On Rise Time                     |   |      | 9.4      |           | ns               |
| $t_{\text{D(off)}}$         | Turn-Off DelayTime                    |   |      | 24       |           | ns               |
| $t_f$                       | Turn-Off Fall Time                    |   |      | 12       |           | ns               |
| $t_{\text{rr}}$             | Body Diode Reverse Recovery Time      | $I_F=-9\text{A}, dI/dt=500\text{A}/\mu\text{s}$                                 |      | 14       | 18        | ns               |
| $Q_{\text{rr}}$             | Body Diode Reverse Recovery Charge    | $I_F=-9\text{A}, dI/dt=500\text{A}/\mu\text{s}$                                 |      | 35       |           | nC               |

- A. The value of  $R_{\text{QIA}}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{ C}$ . The Power dissipation  $P_{\text{DSM}}$  is based on  $R_{\text{QIA}}, t \leq 10\text{s}$  value and the maximum allowed junction temperature of  $150^\circ\text{ C}$ . The value in any given application depends on the user's specific board design, and the maximum temperature of  $150^\circ\text{ C}$  may be used if the PCB allows it.
- B. The power dissipation  $P_D$  is based on  $T_{J(\text{MAX})}=150^\circ\text{ C}$ , using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
- C. Repetitive rating, pulse width limited by junction temperature  $T_{J(\text{MAX})}=150^\circ\text{ C}$ . Ratings are based on low frequency and duty cycles to keep initial  $T_J=25^\circ\text{ C}$ .
- D. The  $R_{\text{QIA}}$  is the sum of the thermal impedance from junction to case  $R_{\text{QJC}}$  and case to ambient.
- E. The static characteristics in Figures 1 to 6 are obtained using  $<300\mu\text{s}$  pulses, duty cycle 0.5% max.
- F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of  $T_{J(\text{MAX})}=150^\circ\text{ C}$ . The SOA curve provides a single pulse rating.
- G. The maximum current rating is package limited.
- H. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{ C}$ .

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**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

**Fig 1: On-Region Characteristics (Note E)**

**Figure 2: Transfer Characteristics (Note E)**

**Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)**

**Figure 4: On-Resistance vs. Junction Temperature (Note E)**

**Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)**

**Figure 6: Body-Diode Characteristics (Note E)**

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**


**Gate Charge Test Circuit & Waveform**

**Resistive Switching Test Circuit & Waveforms**

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